

What is the total RF requirement for FCC Higgs Factory?
How many 400 MHz and 800 MHz cells will be required?
What are the development challenges?
What is the cost impact of Nb/Cu film technology for FCC?

GARD-SRF Roadmap Workshop

9-10 February 2017, FNAL

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Contributions from:

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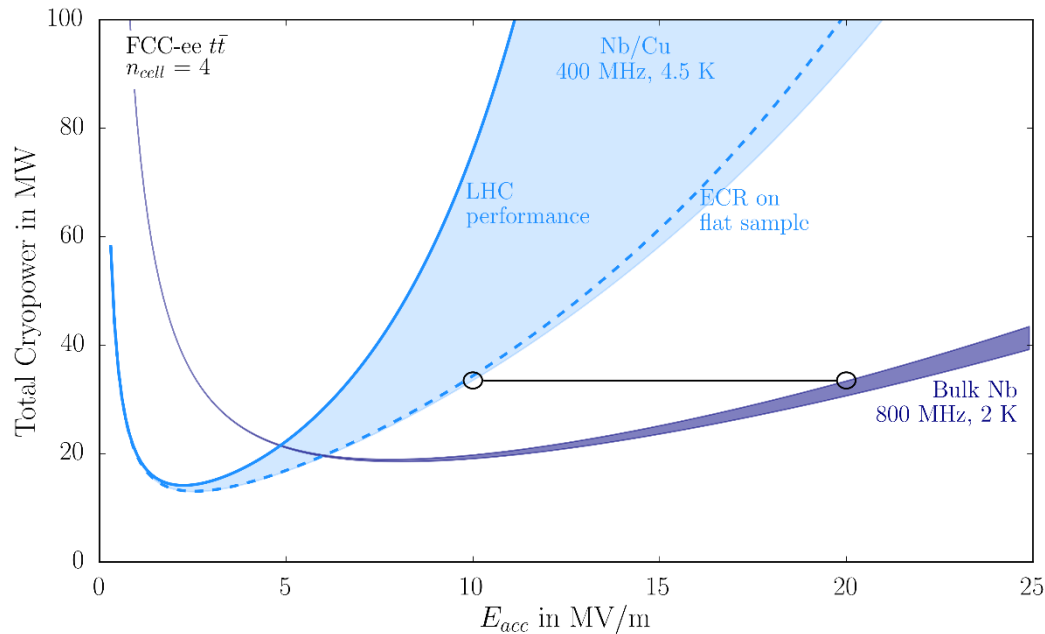
CERN/TE-VSC: S. Calatroni, L. Ferreira, G. Rosaz, A. Sublet

CERN/BE-RF: O. Brunner, N. Schwerg, W. Venturini

RF requirement for FCC-ee Higgs (and top)

	H	$t\bar{t}$
Beam energy in GeV	120	175
Beam current in mA	30	6.6
RF voltage in GV	3	10
Beam lines	2	1

	OPTION 1	OPTION 2
Frequency in MHz	400	800
Technology	Nb/Cu	Bulk Nb
E_{acc} in MV/m	10	20
Temperature in K	4.5	2.0
# of cells/cavity	3 – 5	
# of cavities FCC H	160 – 270	
# of cavities FCC t	530 – 890	
# of CM for FCC H	100	
# of CM for FCC t	170	

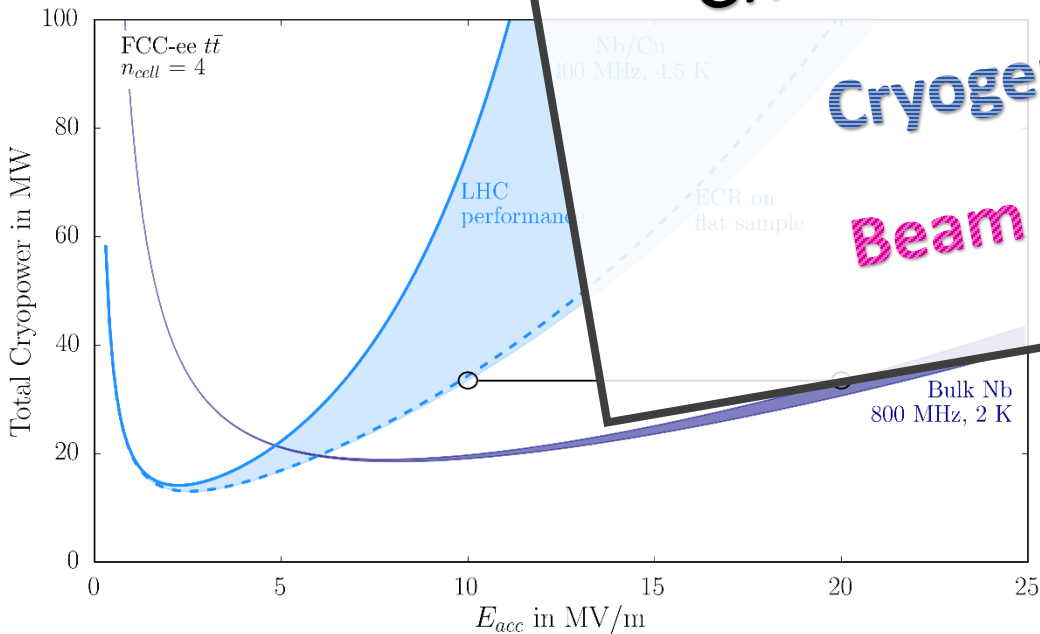


Two competing options for the (S)RF system for FCC-ee H/t

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Challenges for FCC-ee H/t

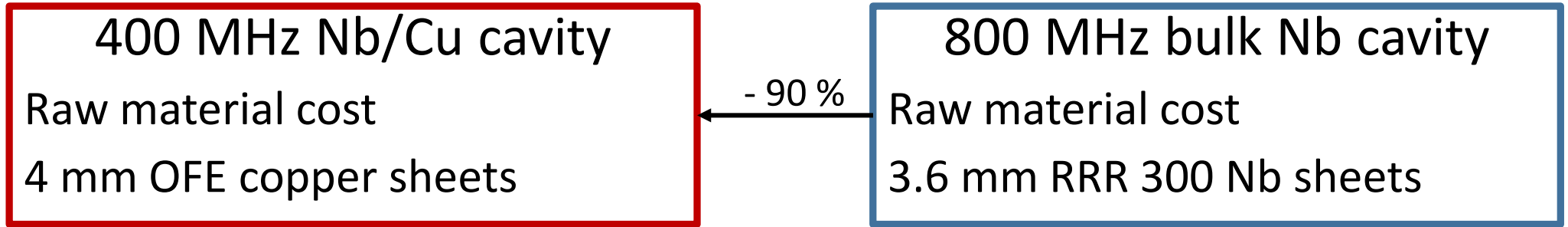
Cryogenic consumption

Beam dynamics issues

Two competing options for the (S)RF system for FCC-ee H/t

Cavity Cost

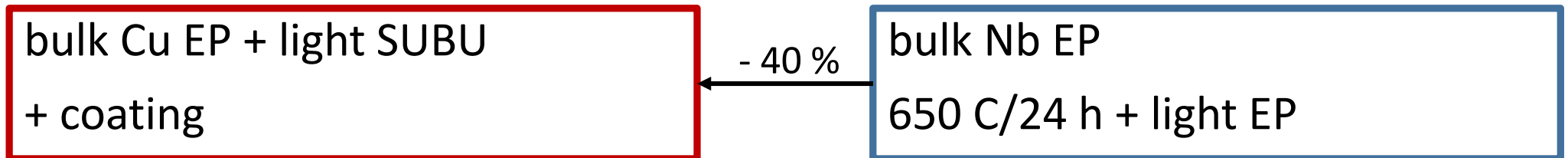
Fabrication



Forming, EBW, mechanical work
(4-cell cavities from half-cells)

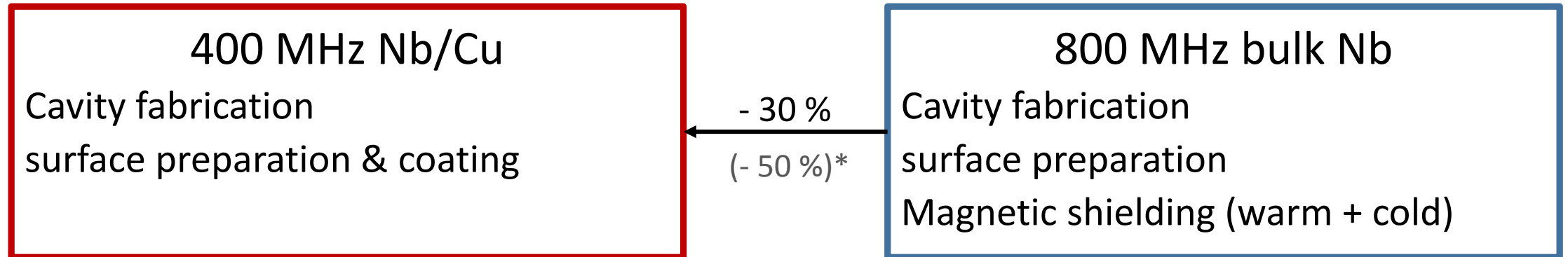
degreasing

Surface Preparation

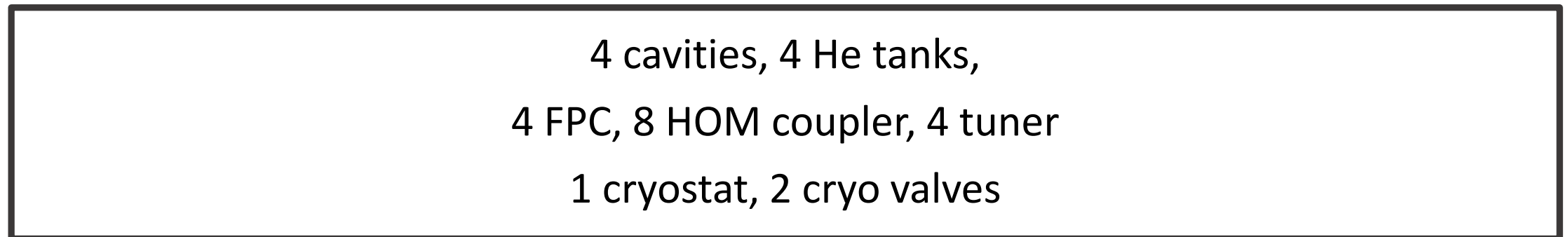


The cost of a 400 MHz copper cavity is about 20-30 % less than for a 800 MHz bulk Nb

Cryomodule Cost



* For seamless cavities and forming cost reduced by 50 %



**The cost for a CM with 400 MHz Nb/Cu cavities is 25-40 %
less than for a CM with 800 MHz bulk Nb cavities**

Cryogenic Plant: Tooling Chemical Hazards

4.5 K vs 2.0 K

Raw material availability

Clean room

Seamless

Helium distribution: requirements for

4.5 K vs 2.0 K

10 MV/m @ 400 MHz

cavities

Micro-

New forming vs 20 MV/m @ 800 MHz

phonics

techniques

Coating

What's missing

Industrialization

Cost for

R&D

Beam dynamics cost

Underground space for a 400

RF Power Sources:

MHz vs a 800 MHz system

400 MHz vs 800 MHz

Summary: FCC RF Parameters

RF Parameters - summary table (6/2/2017)

	FCC_hh	Z		W		H		t	
Ibeam [mA]		1450.0		152.0		30.0		6.6	
Nb bunches		91500	30180	5162		770		78	
RF voltage [GV]	0.03	0.20	0.40	0.80		3.00		10.00	
Energy loss/turn [GeV]		0.03	0.03	0.33		1.67		7.50	
Bunch Length (mm)		3.00	1.60	3.00		3.00		3.00	
frequency [MHz]	400	400	400	400	400	400	800	400	800
cavity technology	Nb/Cu	Nb/Cu	Nb/Cu	Nb/Cu	Nb/Cu	Nb/Cu	Nb	Nb/Cu	Nb
operating temp	4.5	4.5	4.5	4.5	4.5	4.5	2.0	4.5	2.0
accelerating gradient [MV/m]	10	10	10	10	10	10	20	10	20
Nb cavities	32/beam	54/beam	107/beam	214/beam	107/beam	200/beam	200/beam	667	667
Nb cell / cav	1	1	1	1	2	4	4	4	4
coupler type	movable	fixed		fixed		fixed		fixed	
power per cavity [kW]	500	924	462	235	470	251	251	75	75
Q _{ext} matched	2E4 - 9E4	1.7E+05	3.5E+05	6.9E+05	7.0E+05	2.6E+06	2.6E+06	8.9E+06	8.9E+06
RF system length [m]	41	68	136	272	176	480	330	1600	1100
Pcryo tot [MW] @ RT	0.6	1.6	4.1	2.9	2.9	9.8	9.3	32.5	30.0